EACE AND ATASHEET

Smart SIM for Seamless IoT Connectivity

1GLOBAL's secure IoT SIM not only connects your devices securely to our global network, each one is shipped with eSIM technology as standard.

Highlights:

- Simple out of the box connectivity experience;
- Single contract for multi-country deployments with our global network and IoT platform;
- Simplify SIM logistics with a single SKU across the world;
- Better service management control with local operations and direct agreements with Tier 1 providers;
- Faster time-to-market with proven experience to deploy mobile services in new markets;
- Reliable global service focused on quality and fast delivery.

Technical Features:

- Remote SIM provisioning compliant with GSMA M2M and SIMalliance specifications;
- Inbuilt bootstrap connectivity profile;
- Up to 10 operator profiles on a single eSIM;
- Compliant with 2G / 3G / 4G (LTE) / CDMA / NB-IoT / CAT-M networks;
- Network access applications supported: SIM / USIM / ISIM / CSIM;
- Power saving features;
- Secure element access control (ARF / PKCS#15);
- OTA capability over SMS, CAT-TP & HTTPS (including DNS);
- Multi-interfaces able to combine eSIM + eSE.

GLOBAL

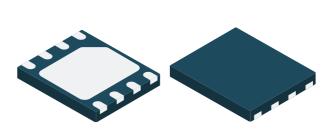
SIM Types

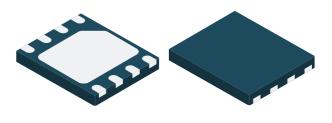
SKU	SIM-S-I03-MFF2-2
Format	MFF2
Dimensions	5x6x1.27mm
Chip Manufacturer	ST Microelectronics
Chip Reference	ST33G1M2
SIM Vendor	ST Microelectronics
Low Power Support	Yes

SKU	SIM-S-I03-MFF2-2-LP
Format	MFF2
Dimensions	5x6x1.27mm
Chip Manufacturer	ST Microelectronics
Chip Reference	ST33G1M2
SIM Vendor	ST Microelectronics
Low Power Support	Yes

SKU	SIM-S-I03-TRI-2
Format	2FF/3FF/4FF
Dimensions	4FF: 12.3x8.8x.67mm
Chip Manufacturer	ST Microelectronics
Chip Reference	ST33G1M2
SIM Vendor	ST Microelectronics
Low Power Support	Yes

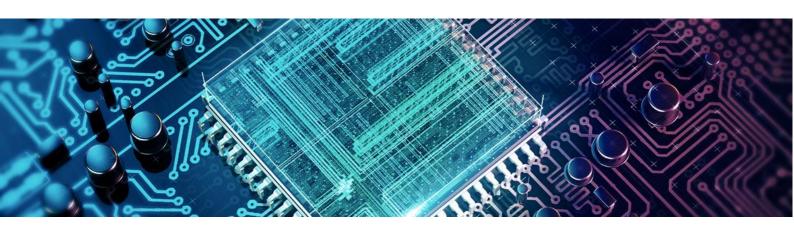
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Hardware Features

Chip Type

Supplier
Chip Codes
Technology
CPU

ST Microelectronics ST33G1M2M 80 nm ARM 32-bit RISC SC300

Qualification

Common Criteria EAL5+ Industrial Qualification (JEDEC JESD47)

Electrical Characteristics

Supply voltage (All formats): Class A (5 V), Class B (3 V), Class C (1.8 V)

Operational Temperature Characteristics

Temperature Range 4FF	-25° to +85°
Extended Range MFF2	-40° to +105°

Supported Clock Division Factors

F/D = 372 (F=372, D=1)	Yes
F/D = 64 (F=512, D=8)	Yes
F/D = 32 (F=512, D=16)	Yes
F/D = 16 (F=512, D=32)	Yes
F/D = 8 (F=512, D=64)	Yes

Memory Sizes

Total Flash size	1280K
Flash available to customer	380K / 512K (Ext)
RAM Total / For applets	30K / 7K

NVRAM characteristics

Endurance cycles (min) @25°	100K / 500K (Ext)
Data retention (min) @25°	10 Y / 25 Y (Ext)
Page/Sector erase time	3ms/6ms
Page write time	2.5ms

Cryptographic Features and Accelerators

Crypto-coprocessor	Yes
3DES engine	Yes
AES engine	Yes
True RNG	Yes
CRC	Yes
CPA /DPA Countermeasures	Yes

Form Factors

3 in 1 Plug-In SIM (2FF, 3FF and 4FF)	Yes
DFN8 (MFF2)	Yes
WLCSP	Yes



Memory Management

Software Features

UICC Java Card	Release 12 3.0.4	Journaling File System	Yes (Option)
		Dynamic Memory Management	Yes
Global Platform Certified	2.2 (Amd. A,B,C,D,E)	Administration	
SIMAlliance IPP	2.1	Administration	
GMSA RSP SGP.02 M2M	3.2	Administrative Commands	Release 12
Power Saving Features (PSM, eDRX)	ETSI R13		
	LIGHTO	Remote Management	
Supported Applications		Remote File Management	Release 12
USIM	Release 12	Remote Applet Management	Release 12
ISIM	Release 12	SMS Concatenation Size	configurable
EAP	Release 12	BIP	Release 12
		CAT_TP	Release 12
Multiplication Features		HTTPS Remote Management	Yes
-			
Single SIM/ multiple USIMs / ISIMs	Yes	Authentication Algorithms	
Single SIM/ multiple USIMs / ISIMs Number of Logical Channels	Yes 4	Authentication Algorithms 2G COMP128-1,2,3	Yes
Number of Logical Channels		•	Yes Yes
Number of Logical Channels Supported Java Card APIs	4	2G COMP128-1,2,3	
Number of Logical Channels Supported Java Card APIs UICC API	4 Release 12	2G COMP128-1,2,3 2G GSM-MILENAGE	Yes
Number of Logical Channels Supported Java Card APIs UICC API USIM API	4 Release 12 Release 12	2G COMP128-1,2,3 2G GSM-MILENAGE 3G MILENAGE	Yes Yes
Number of Logical Channels Supported Java Card APIs UICC API USIM API ISIM API	4 Release 12 Release 12 Release 12	2G COMP128-1,2,3 2G GSM-MILENAGE 3G MILENAGE GBA Support	Yes Yes Yes
Number of Logical Channels Supported Java Card APIs UICC API USIM API	4 Release 12 Release 12	2G COMP128-1,2,3 2G GSM-MILENAGE 3G MILENAGE GBA Support TUAK	Yes Yes Yes Yes
Number of Logical Channels Supported Java Card APIs UICC API USIM API ISIM API	4 Release 12 Release 12 Release 12	2G COMP128-1,2,3 2G GSM-MILENAGE 3G MILENAGE GBA Support TUAK ECC (NIST P-256, brainpoolIP256r1)	Yes Yes Yes Yes Yes
Number of Logical Channels Supported Java Card APIs UICC API USIM API ISIM API Global Platform API	4 Release 12 Release 12 Release 12	2G COMP128-1,2,3 2G GSM-MILENAGE 3G MILENAGE GBA Support TUAK ECC (NIST P-256, brainpoolIP256r1)	Yes Yes Yes Yes Yes
Number of Logical Channels Supported Java Card APIs UICC API USIM API ISIM API Global Platform API Supported Protocols	4 Release 12 Release 12 Release 12 2.2.1	2G COMP128-1,2,3 2G GSM-MILENAGE 3G MILENAGE GBA Support TUAK ECC (NIST P-256, brainpoolIP256r1)	Yes Yes Yes Yes Yes





MFF2 Pin Out

This package is compatible with the MFF2 package defined by ETSI 102 671 release 12.

Figure 1. VFDFPN8 pinout (top view)

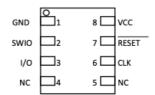
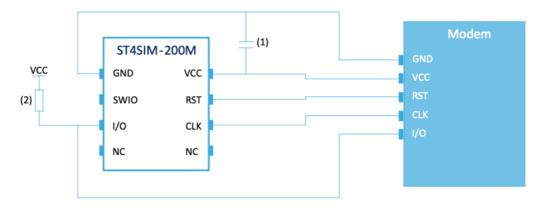


Table 1. Pin descriptions

Name	Description	Pin state
GND	Ground supply	-
SWIO	Not used	Input pull-up
RESET	External reset	Input pull-down
I/O	Input/output	Pull-down then pull-up after card activation
CLK	External clock	Pull-down
VCC	Power supply	-
NC	Not connected internally	-

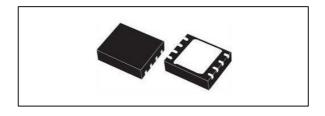
Figure 2. ST4SIM-200M PCB integration recommendations



Packaging information

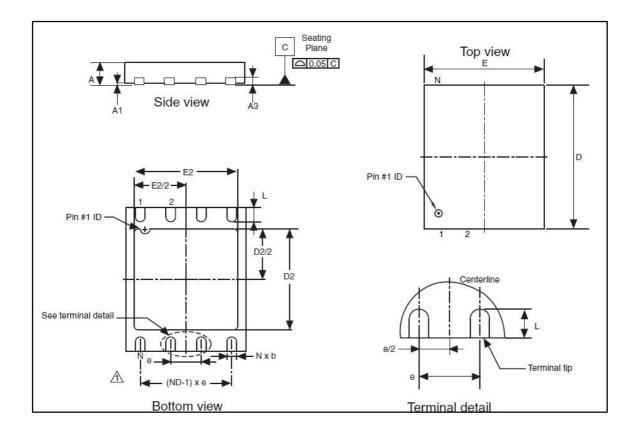
This section of the document defines the packaging requirements for M2M personalized products, based on the DFN8/MFF2 5 \times 6 mm package.

Package silhouette



Package mechanical data





Symbol Min.	millimeters			inches ⁽¹⁾			
	Тур.	Max.	Min.	Тур.	Max.		
A	0.800	0.900	1.000	0.0315	0.0354	0.0394	
A1	0.000	0.020	0.050	0.0000	0.0008	0.0020	
A3		0.200			0.0079		
b	0.350	0.400	0.480	0.0138	0.0157	0.0189	
D	5.900	6.000	6.100	0.2322	0.2362	0.2401	
D2	3.300	3.400	3.500	0.1299	0.1339	0.1378	
E	4.900	5.000	5.100	0.1929	0.1969	0.2007	
E2	4.100	4.200	4.300	0.1614	0.1654	0.1693	
е		1.270			0.0500		
L	0.500	0.600	0.750	0.0197	0.0236	0.0295	

5 × 6 mm, 0.9 mm thickness package mechanical data

1. Values in inches are converted from mm and rounded to 4 decimal digits.

Note: 1 'N' is the total number of terminals.

- 2 'ND' refer to the number of terminals on side D.
- 3 Max. package warpage is 0.05 mm.
- 4 Max. allowable burrs is 0.076 mm in all directions.
- 5 Pin #ID on top will be laser marked.

Tape and reel packaging

Surface-mount packages can be supplied with Tape and Reel packing. Typical reels diameter 13" (4000 devices).

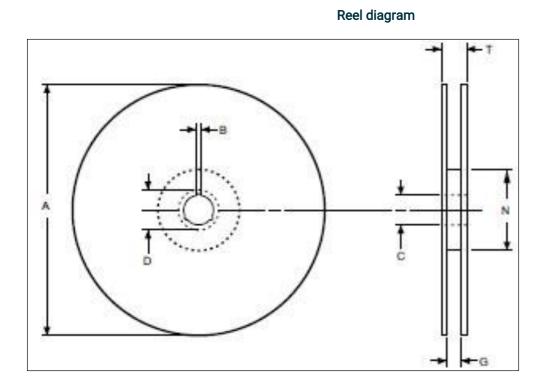
Reels are in plastic, either antistatic or conductive, with a black conductive cavity tape.

The cover tape is transparent antistatic or conductive.

The STMicroelectronics Tape & Reel specifications are compliant to the EIA 481-A standard specification.

Package	Description	Tape width	Tape pitch	Reel diameter	Quality per reel
DFN 5 x 6	Flat package no. lead 5 x 6 mm	14 mm	8mm	13 in.	4000

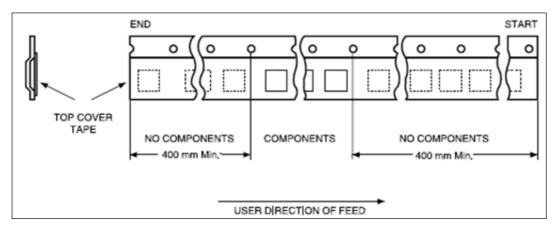
Packages on tape and reel



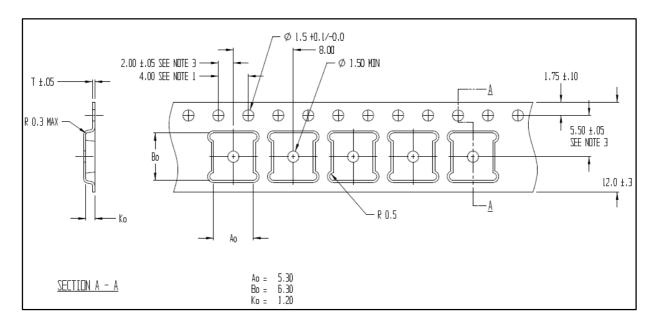
Reel dimensions

Reel size	Tape size	A max	B min	С	D min	G max	N min	T max	Unit
13"	12 mm	330	1,5	13 ±0,25	20,2	12,6	100	18,4	mm

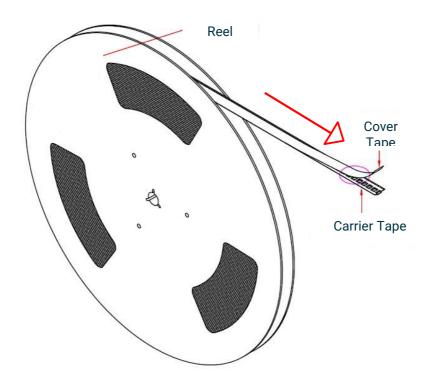
Leader and trailer

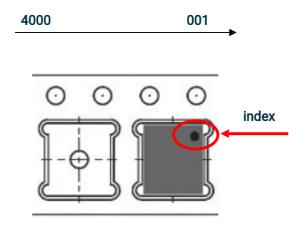


Embossed carrier tape



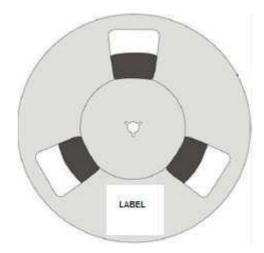
Component orientation





Identification reel

A dedicated label with logistic information shall be placed onto the reel.



Dry packaging of reel in moisture barrier bag

The reel is packed in a moisture barrier bag.

In the bag is inserted a humidity indicator card and desiccant bag.



On the moisture barrier bag are stuck the labels:

- 1) Moisture sensitive caution label
- 2) A logistic label containing reel information (as per customer request)



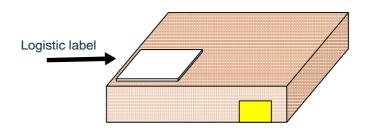
This package is qualified in compliance with JEDEC J-STD-020D and MSL 1 specifications.

Shipping box and packaging

The reel, shrunken inside the moisture barrier bag, shall be shipped in a dedicated shipping box. The packed reel is put in a cardboard box of dimensions 365x350x45 mm.

On the top is stuck a logistic label containing reel information (as per customer request)

The box shall be sealed with a security tape.

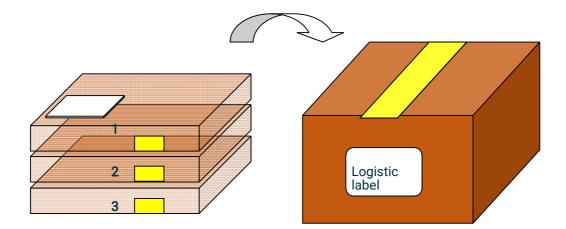


Packaging in the over box: "three shipping boxes = 12.000 pcs." - results in outer box max external dimensions:

- X: 395 mm
- Y: 375 mm



• H: 170 mm



A dedicated outer box label with logistic information shall be placed centered to the front side of the outer box.

The outer boxes shall be sealed with a security tape.

Standard Label

The following label will be applied on the reel, moisture barrier bag, cardboard box and if necessary, also on the overbox:

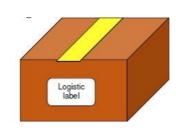


Date	Туре	Print Format	Digit	Min Barcode degree
Purchase Order P/O	V	Numeric	10	NA
Purchase Order P/O	V	BarCode 128	10	D
Start Serial	V	Numeric	20	NA
Start Serial	V	BarCode 128	20	D
End Serial	V	Numeric	20	NA
End Serial	V	BarCode 128	20	D
CP Commercial Product	F	*****	NA	NA
CP Commercial Product	F	BarCode 128 XXXXXXXXXXXX	NA	D
Lot Code	V	xxxxxxxxxxx	NA	NA
Lot Code	V	BarCode 128 XXXXXXXXXXXXX	NA	D
QTY	V	Numeric	4	NA
QTY	V	BarCode 128	4	D
COO	F	IT	2	NA
COO	F	BarCode 128	2	D
Dcode	V	YYWW	4	NA
Dcode	V	YYWW BarCode 128	4	D
Package Count	V	Reel identification in relation to the total of the reel belonging to the order	6	NA
PAckage Count	V	BarCode 128 Reel identification in relation to the total of the reel belonging to the order	6	D



Note: V = variable data; F = fixed data

OVERBOX LABELS (the overbox can include max 3 box):



		RDER: XX	
MANU	JFACTUR	NAMES OF A DESCRIPTION	

4

COMMERCIAL PRODUCT: XXXXXXXXXXXXX (4L) MADE IN ITALY 15000 QTY:

PACKAGE COUNT: 01 OF 03



STMicroelectronics

Date	Туре	Print Format	Digit	Min Barcode degree
Purchase Order P/O	V	Numeric	10	NA
Purchase Order P/O	V	BarCode 128	10	D
Manufacturer	F	ST	2	NA
Manufacturer	F	ST	2	NA
Commercial Product	F	XXXXXXXXXXXXX	NA	NA



Commercial	F	BarCode 128	NIA	D
Product	F	xxxxxxxxxxxx	NA	D
QTY	V	Numeric	4-5	NA
QTY	V	BarCode 128	4-5	D
4L) MADE IN ITALY	F	FIXED STRING (4L) MADE IN ITALY	18	NA
ITALY	F	BarCode 128	13	D
Package Count	V	"0X" OF "0Y" where 0X indicates the box number, while 0Y indicates the total number of boxes. For example, if the production is 35,000 chips, there will be 3 boxes that will report respectively: 01 OF 03, 02 OF 03, 03, 0F, 03	6	NA
Package Count	V	BarCode 128 "0X" OF "0Y" where 0X indicates the box number, while 0Y indicates the total number of boxes	6	D

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

1Global:

<u>SIM-S-IO3-MFF2-2-LP-RESELL_LP_125MB_1Y</u> <u>SIM-S-IO3-MFF2-2-LP-RESELL_LP_125MB_3Y</u> <u>SIM-S-IO3-MFF2-2-LP-RESELL_LP_250MB_3Y</u> <u>SIM-S-IO3-MFF2-2-LP-RESELL_LP_50MB_1Y</u> <u>SIM-S-IO3-MFF2-2-LP-RESELL_LP_Trial</u> <u>SIM-S-IO3-MFF2-2-RESELL_CRITICAL_1GB_1Y</u> <u>SIM-S-IO3-MFF2-2-RESELL_CRITICAL_1GB_3Y</u> <u>SIM-S-IO3-MFF2-2-RESELL_CRITICAL_3GB_1Y</u> <u>SIM-S-IO3-MFF2-2-RESELL_CRITICAL_5GB_3Y</u> <u>SIM-S-IO3-MFF2-2-RESELL_CRITICAL_5GB_3Y</u> <u>SIM-S-IO3-MFF2-2-RESELL_CRITICAL_5GB_3Y</u> <u>SIM-S-IO3-MFF2-2-RESELL_CRITICAL_5GB_3Y</u> <u>SIM-S-IO3-MFF2-2-RESELL_CRITICAL_5GB_3Y</u> <u>SIM-S-IO3-MFF2-2-RESELL_CRITICAL_5GB_3Y</u> <u>SIM-S-IO3-TRI-2-LP-RESELL_LP_125MB_1Y</u> <u>SIM-S-IO3-TRI-2-LP-RESELL_LP_250MB_3Y</u> <u>SIM-S-IO3-TRI-2-LP-RESELL_LP_50MB_1Y</u> <u>SIM-S-IO3-TRI-2-LP-RESELL_LP_50MB_1Y</u> <u>SIM-S-IO3-TRI-2-LP-RESELL_LP_50MB_1Y</u> <u>SIM-S-IO3-TRI-2-LP-RESELL_LP_50MB_1Y</u> <u>SIM-S-IO3-TRI-2-LP-RESELL_CRITICAL_1GB_1Y</u> <u>SIM-S-IO3-TRI-2-RESELL_CRITICAL_1GB_1Y</u> <u>SIM-S-IO3-TRI-2-RESELL_CRITICAL_3GB_1Y</u> <u>SIM-S-IO3-TRI-2-RESELL_CRITICAL_1GB_1Y</u> <u>SIM-S-IO3-TRI-2-RESELL_CRITICAL_1GB_1Y</u> <u>SIM-S-IO3-TRI-2-2</u>